



- A1** EMS Electronic manufacturing services, PCBs and other circuit carriers
- A2** Electromechanics and system peripherals, Interconnection components
- A2** Electromechanics and system peripherals, Interconnection components, Relays, switches and keyboards
- B3** Electromechanics and system peripherals, Interconnection components, Casing technology
- A3** Test and measurement
- A4** Power supplies
- A5** Passive components
- B3** Sensor technology, Micro- and nanosystems (NEMS, MEMS)
- B4** Embedded systems
- B4** Semiconductors
- B5** Displays
- B5** Automotive
- B5** Wireless
- B1** SEMICON Europa 2022
- B1** SEMICON EUROPA
- C1** ED/EDA
- all halls** Servo-technology
- all halls** Assemblies and subsystems
- all halls** Services
- ICM** **Conferences**
 electronica Automotive Conference
 electronica Embedded Platforms Conference
 Wireless Congress: Systems & Applications
- SEMICON Europa Conferences**
 Advanced Packaging Conference
 Fab Management Forum
 ITF Beyond 5G—powered by imec

- electronica Forums**
- 1** PCB & Components Marketplace
 - 2** Power Electronics/Embedded systems
 - 3** Electrical Connectors/Masurement Technology
 - 4** IIoT/Cyber Security
 - 5** Automotive/Printed Electronics

- SEMICON Europa Forums**
- 6** TechARENA
 - 7** Executive Forum

- Talent meets Industry**
- 8** electronica Career Area
 - 9** electronica Fast Forward
 - 10** electronica Student Day



Planning status as of: 9/2022
(Subject to change)